onsemi

General Purpose Transistors PNP Silicon NST857AMX2, NST857BMX2

Features

• These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise noted)

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	-45	V
Collector-Base Voltage	V _{CBO}	-50	V
Emitter-Base Voltage	V _{EBO}	-5.0	V
Collector Current – Continuous	Ι _C	-100	mA

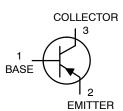
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Power Dissipation (Note 1) @ T _A = 25°C Derate above 25°C	P _D	166 1.39	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 1)	R_{\thetaJA}	722	°C/W
Total Power Dissipation (Note 2) @ T _A = 25°C Derate above 25°C	P _D	640 5.41	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	R_{\thetaJA}	185	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	–55 to +150	°C

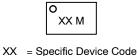
1. Surface-mounted on FR4 board using a 0.6 mm², 2 oz. Cu pad

2. Surface-mounted on FR4 board using a 100 mm², 2 oz. Cu pad





MARKING DIAGRAM



XX = Specific Device Code M = Date Code

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

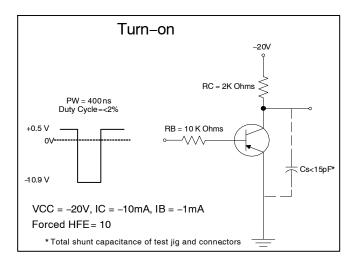
ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS				•		
Collector – Emitter Breakdown Voltage	(I _C = -10 mA)	V _{(BR)CEO}	-45	-	-	V
Collector – Emitter Breakdown Voltage (I _C = -10 μA, V _{EB} = 0)	V _{(BR)CES}	-50	-	-	V
Collector – Base Breakdown Voltage	(I _C = −10 μA)	V _{(BR)CBO}	-50	-	-	V
Emitter-Base Breakdown Voltage	(I _E = −1.0 μA)	V _{(BR)EBO}	-5.0	-	-	V
Collector Cutoff Current (V _{CB} = -30 V) (V _{CB} = -30 V, T _A = 150° C)		I _{CBO}			-15 -4.0	nA μA
ON CHARACTERISTICS						
DC Current Gain (I _C = -100 μ A, V _{CE} = -1.0 V)	NST857A NST857B	h _{FE}		180 270		-
$(I_{C} = -2.0 \text{ mA}, V_{CE} = -5.0 \text{ V})$	NST857A NST857B		125 220	180 290	250 475	
Collector – Emitter Saturation Voltage ($I_C = -10 \text{ mA}, I_B = -0.5 \text{ mA}$) ($I_C = -100 \text{ mA}, I_B = -5.0 \text{ mA}$)		V _{CE(sat)}			-0.3 -0.65	V
Base – Emitter Saturation Voltage ($I_C = -10 \text{ mA}, I_B = -0.5 \text{ mA}$) ($I_C = -100 \text{ mA}, I_B = -5.0 \text{ mA}$)		V _{BE(sat)}		-0.7 -0.9		V
Base – Emitter On Voltage ($I_C = -2.0 \text{ mA}$, $V_{CE} = -5.0 \text{ V}$) ($I_C = -10 \text{ mA}$, $V_{CE} = -5.0 \text{ V}$)		V _{BE(on)}	-0.6 -		-0.75 -0.82	V
SMALL-SIGNAL CHARACTERISTICS						
Current-Gain - Bandwidth Product ($I_C = -10 \text{ mA}, V_{CE} = -5.0 \text{ Vdc}, f = 100 \text{ MHz}$)		f _T	100	-	-	MHz
Output Capacitance ($V_{CB} = -10 \text{ V}, \text{ f} = 1.0 \text{ MHz}$)		C _{ob}	-	-	4.5	pF
Noise Figure		NF	1			dB

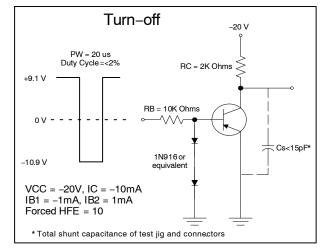
Noise Figure $(I_{C} = -0.2 \text{ mA}, V_{CE} = -5.0 \text{ Vdc}, R_{S} = 2.0 \text{ k}\Omega, f = 1.0 \text{ kHz}, BW = 200 \text{ Hz})$

NST857B Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

NST857A





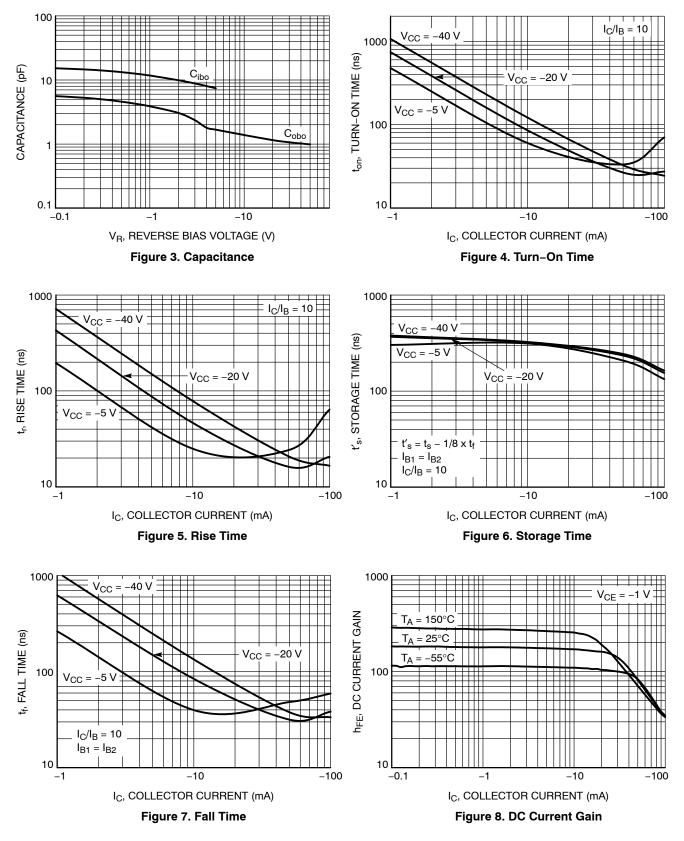


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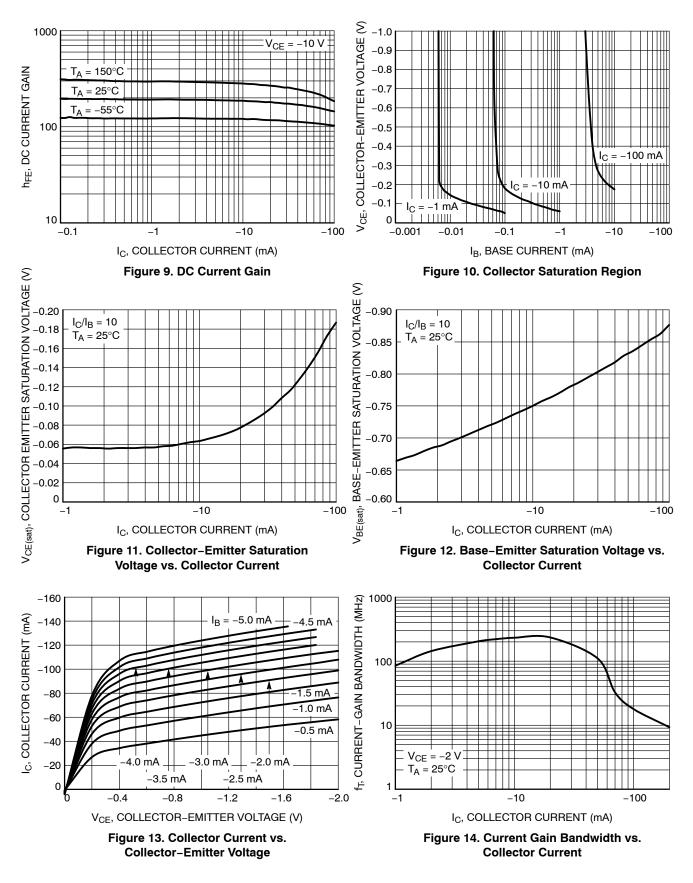
4.0

Figure 2. Storage and Fall Time Equivalent **Test Circuit**

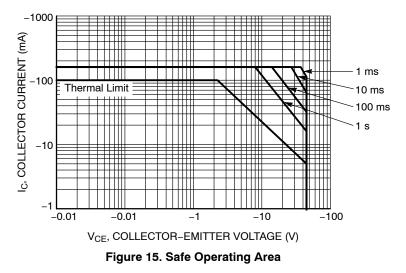




TYPICAL CHARACTERISTICS – NST857AMX2



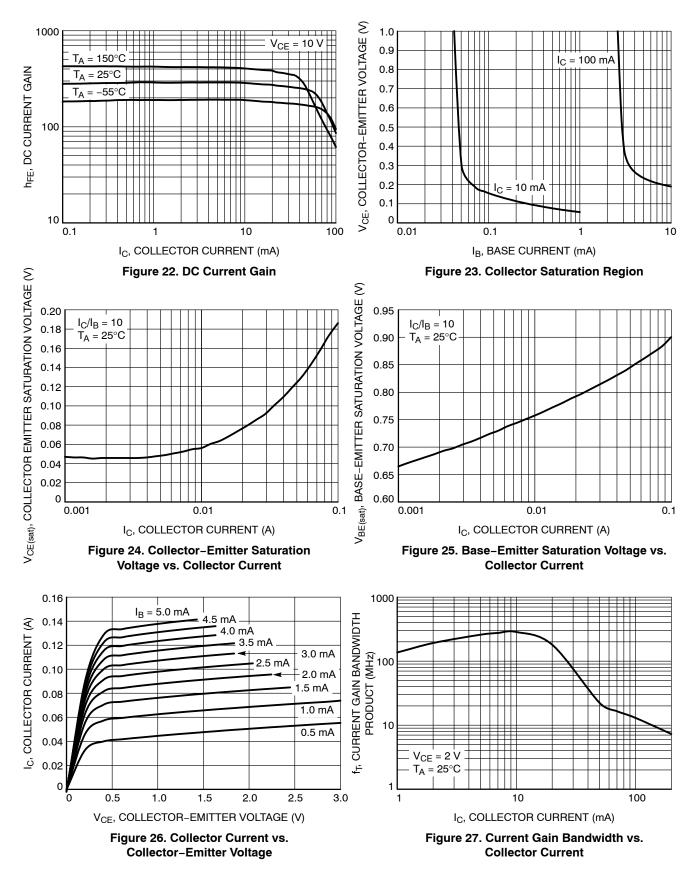
TYPICAL CHARACTERISTICS - NST857AMX2



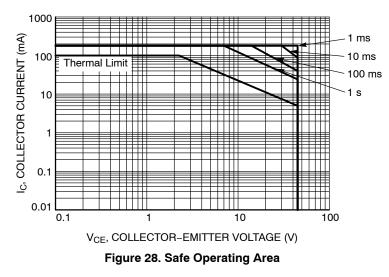
10 1000 V_{CC} = 40 V $I_{\rm C}/I_{\rm B} = 10$ Cibo ton, TURN-ON TIME (ns) CAPACITANCE (pF) $V_{CC} = 20 V$ 100 $V_{CC} = 5 V$ 0.1 10 100 0.1 10 100 10 1 1 **REVERSE BIAS VOLTAGE (V)** I_C, COLLECTOR CURRENT (mA) Figure 16. Capacitance Figure 17. Turn-On Time 1000 1000 $I_{\rm C}/I_{\rm B}=10$ V_{CC} = 40 V ťs, STORAGE TIME (ns) t_r, RISE TIME (ns) V_{CC} = 40 V V_{CC} = 20 V V_{CC} = 20 V 100 V_{CC} = 5 V $V_{CC} = 5 V$ $t'_s = t_s - 1/8 \ x \ t_f$ $\mathsf{I}_{\mathsf{B}1} = \mathsf{I}_{\mathsf{B}2}$ $I_{\rm C}/I_{\rm B}=10$ 10 100 10 100 10 100 1 1 IC, COLLECTOR CURRENT (mA) I_C, COLLECTOR CURRENT (mA) Figure 18. Rise Time Figure 19. Storage Time 1000 1000 V_{CC} = 40 V I_{B1} $T_A = 150^{\circ}C$ h_{FE}, DC CURRENT GAIN $T_A = 25^{\circ}C$ t_f, FALL TIME (ns) $T_A = -55^{\circ}C$ V_{CC} = 20 V 100 100 $V_{CC} = 5 V$ 10 10 10 100 100 0.1 10 1 1 IC, COLLECTOR CURRENT (mA) IC, COLLECTOR CURRENT (mA) Figure 20. Fall Time Figure 21. DC Current Gain

TYPICAL CHARACTERISTICS – NST857BMX2

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TYPICAL CHARACTERISTICS – NST857BMX2

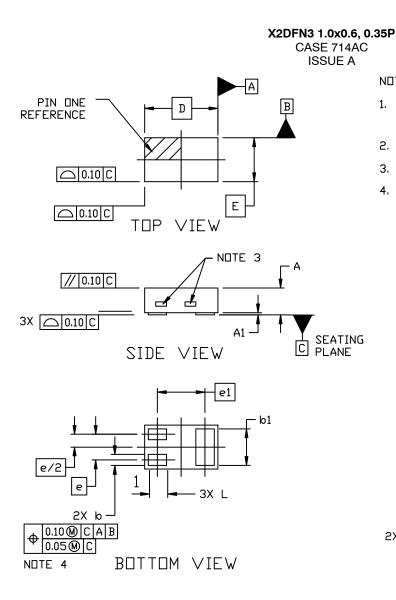


ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NST857AMX2T5G	AC	X2DFN3 (1.0 x 0.6 mm)	8,000 / Tape & Reel
NST857BMX2T5G	AJ	(1.0 x 0.0 mm)	

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

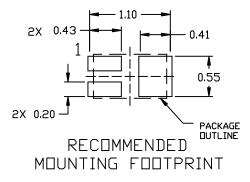
PACKAGE DIMENSIONS



NDTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. EXPOSED COPPER ALLOWED AS SHOWN.
- 4. ALL PAD LOCATIONS CONTROLLED WITH THIS POSITIONAL TOLERANCE.

	MILLIMETERS			
DIM	MIN.	MAX.	MAX.	
A	0.34	0.37	0.40	
A1	0.00		0.05	
ю	0.10	0.15	0.20	
b1	0.45	0.50	0.55	
D	0.95	1.00	1.05	
E	0.55	0.60	0.65	
e	0.35 BSC			
e1	0.65 BSC			
L	0.20	0.25	0.30	



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PUBLICATION ORDERING INFORMATION

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onsemi Website: www.onsemi.com

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